

- Wide Input Voltage Range: 3.1V-50V
- Low Shutdown Current 3.9uA
- Low Quiescent Operating Current: 415uA
- +/- 1.5% Feedback Reference Voltage
- Adjustable Switching Frequency: 100KHz to 2.2MHz
- External Frequency Synchronic
- External Compensation
- Pulse Skipping Mode
- Supports additional Slope Compensation
- 14ms Internal Soft-start Time
- Integrated Protection Feature
  - Constant Peak-Current Protection Threshold Over Input Voltage
  - Output Overvoltage Protection
  - Adjustable Under-voltage Lockout
  - Thermal Shutdown Protection:165°C
- MSOP-10L(3mm\*3mm)

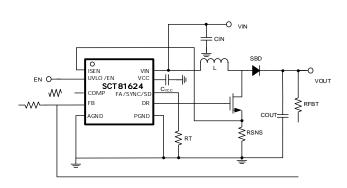
The SCT81624 device is a wide input, nonsynchronous boost controller. The device can be used in Boost, SEPIC and Flyback converters.

The switching frequency of the SCT81624 device can be adjusted to any value between 100kHz and 2.2MHz by using a single external resistor or by synchronizing it to an external clock. Current mode control provides superior bandwidth and transient response in addition to cycle-by-cycle current limiting. Current limit is adjustable through an external resistor.

The SCT81624 device has built-in protection features such as thermal shutdown, over-current protection and overvoltage protection. Power-saving shutdown mode reduces the total supply current to 3.9  $\mu$ A. Integrated current slope compensation simplifies the design and, if needed for specific applications, can be increased using a single resistor.

The device is available in a MSOP-10L(3mm\*3mm) Package.

- Multi-output FlybackLED Bias Supply
- Portable Speaker Supply
- Battery Powered Boost/Flyback/SEPIC application



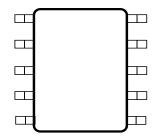


NOTE: Page numbers for previous revisions may differ from page numbers in the current version Revision 1.0: Released to Market

PART NUMBER	PACKAGE MARKING	PACKAGE DISCRIPTION		
SCT81624MRD	1624	10-Lead 3mm×3mm Plastic MSOP		
1) For Tape & Reel, Add Suffix R (e.g. SCT81624MRDR)				

Over operating free-air temperature	unless otherv	vise noted <sup>(1)</sup>

DESCRIPTION	MIN	МАХ	UNIT
VIN, UVLO_EN	-0.3	62	V
VCC, DR	-1	6.6	V
ISEN, COMP, FB, FA/SYNC/SD	-5	5.5	V
Peak Driver Output Current		1 <sup>(2)</sup>	Α
Junction temperature <sup>(2)</sup>	-40	150	С
Storage temperature TSTG	-65	150	С



Top View: 10-Lead Plastic MSOP 3mmx3mm

(1) Stresses beyond those listed under Absolute Maximum Rating may cause device permanent damage. The device is not guaranteed to function outside of its Recommended Operation Conditions.

(2) Guaranteed by design, not tested in productions.

(3) The IC includes over temperature protection to protect the device during overload conditions. Junction temperature will exceed 170°C when over temperature protection is active. Continuous operation above the specified maximum operating junction temperature will reduce lifetime.



NAME	NO.	DESCRIPTION
DR	8	N-channel MOSFET gate drive output. Connect directly to the gate of the N- channel MOSFET through a short, low inductance path.
VCC	9	



SYMBOL	PARAMETER	TEST CONDITION	MIN	ΤΥΡ	MAX	UNIT
Power Supply	and Output					
VIN	Operating input voltage		3.1		50	V
VIN_UVLO	Input UVLO Hysteresis	V <sub>IN</sub> rising		2.8 160		V mV
Isd	Shutdown current	V <sub>FA/SYCN/SD</sub> =5V or V <sub>UVLO_EN</sub> =0		3.9	8	uA
lq	Quiescent current from VIN	no load, no switching, V <sub>FB</sub> =2V		415		uA
SUPPLY <sup>(1)</sup>	Supply Current	R <sub>FA/SYNC/SD</sub>	2			mA
VCC Power						
V <sub>cc</sub>	Internal linear regulator	VIN>7V		6.1		V
V <sub>CC_uvlo</sub>				2.85		V
V <sub>CC_uvlo_hys</sub>				75		mV
IVcc	VCC Sourcing current limit		20	70		mA
		1				
VUVLOSEN	Under voltage Lockout reference voltage	V <sub>UVLO</sub> ramping up	1.34	1.42	1.5	V
I <sub>UVLO</sub>	UVLO source current		3	4.75	6.5	uA
VUVLOSD	UVLO shut down voltage	VUVLO ramping down	0.55	0.65	0.75	V
Reference and	I Control Loop	1				I
Vref	Reference voltage of FB		1.256	1.275	1.294	V
IFB	FB pin leakage current	V <sub>FB</sub> =1V			100	nA
G <sub>EA</sub>	Error amplifier trans-conductance	V <sub>COMP</sub> =1.5V	190	390	590	uS
ICOMP_SRC	Error amplifier maximum source current	V <sub>FB</sub> =V <sub>REF</sub> -200mV, V <sub>COMP</sub> =1.5V	340	560	710	uA
ICOMP_SNK	Error amplifier maximum sink current	V <sub>FB</sub> =V <sub>REF</sub> +200mV, V <sub>COMP</sub> =1.5V	-150	-95	-40	uA
V <sub>COMP_H</sub>	COMP high clamp	V <sub>FB</sub> =0.8V	1.9	2.55	3.2	V
VCOMP_L	COMP low clamp	V <sub>FB</sub> =1.7V	0.4	0.88	1.2	V
Gate Driver						
RDSON_TOP	Driver switch on resistance(top)	I <sub>DR</sub> =0.1A		3		
R <sub>DSON_LOW</sub>	Driver switch on resistance(bottom)	I <sub>DR</sub> =0.1A		2		
Current Sense						
Vsense	Current sense threshold		120	146	170	mV
$V_{SL}^{(2)}$	Internal compensation Ramp voltage			90		mV

V<sub>IN</sub>=12V, T<sub>J</sub>=-40°C~125°C, typical values are tested under 25°C.



SYMBOL	PARAMETER	TEST CONDITION	MIN	ТҮР	MAX	UNIT
Soft start						
Tss	Soft-start Time		14 m		ms	
Switching Frequency						
Fsw	Switching frequency	R				

VIN=12V, TJ=-40°C~125°C, typical values are tested under 25°C.



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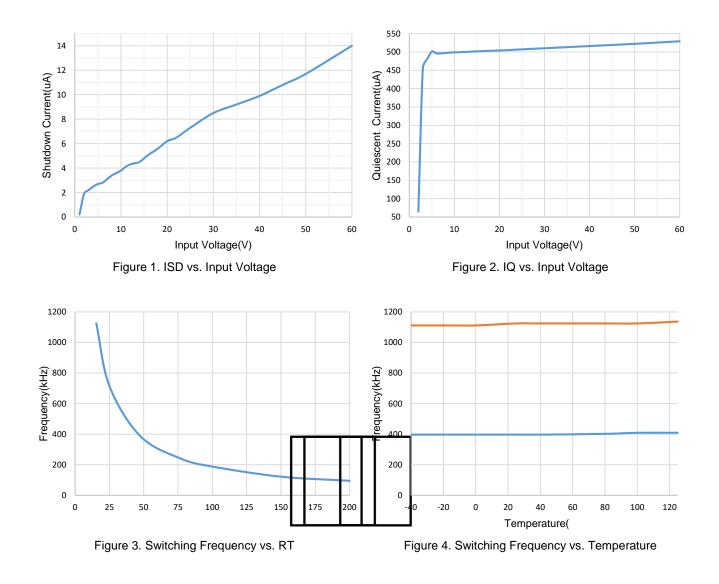
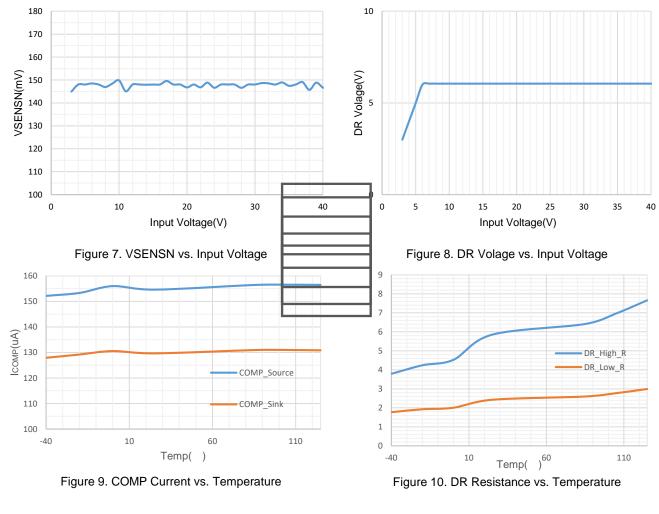


Figure 5. Efficiency vs Load Current, Boost, VOUT=12V

Figure 6. Efficiency vs Load Current, Sepic, VOUT=12V



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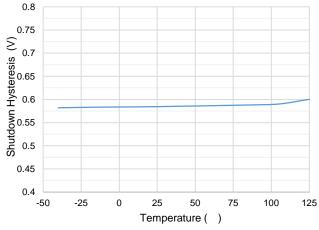
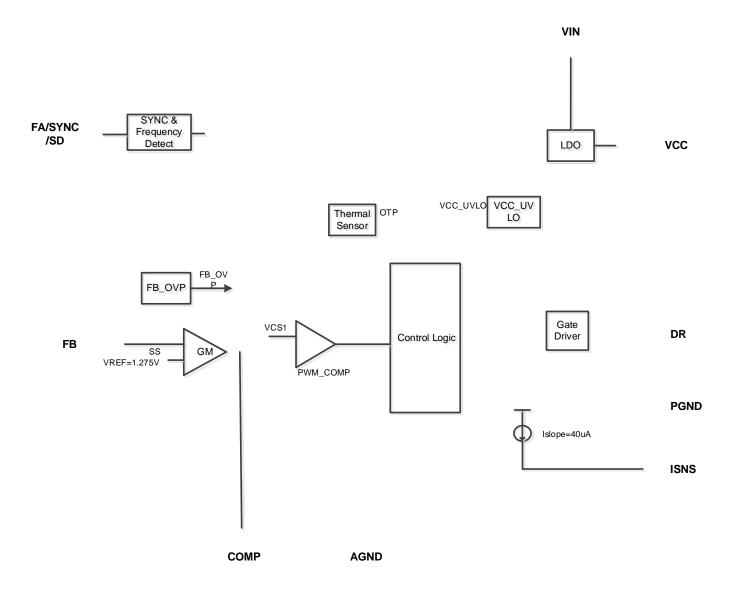


Figure 11. Shutdown Threshold Hysteresis vs. Temperature







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## Overview

The SCT81624 device is a wide input range, non-synchronous boost controller that uses peak-current-mode control. The device can be used in boost, SEPIC, and flyback topologies.

In a typical application circuit, the peak current through the external MOSFET is sensed through an external sense resistor. The voltage across this resistor is fed into the ISNS pin. This voltage is fed into the positive input of the PWM comparator. The output voltage is also sensed through an external feedback resistor divider network and fed into the error amplifier negative input. The output of the error amplifier (COMP pin) is added to the slope compensation ramp and fed into the negative input of the PWM comparator. At the start of any switching cycle, the oscillator sets the RS latch using the switch logic block. This forces a high signal on the DR pin (gate of the external MOSFET) and the external MOSFET turns on. When the voltage on the positive input of the PWM comparator exceeds the negative input, the RS latch is reset and the external MOSFET turns off. The voltage sensed across the sense resistor generally contains spurious noise spikes. These spikes can force the PWM comparator to reset the RS latch prematurely. To prevent these spikes from resetting the latch, a blank-out circuit inside the IC prevents the PWM comparator from resetting the latch for a short duration after the latch is set. This duration is called the blanking interval and is specified as minimum on-time in the Electrical Characteristics section. Under extremely light-load or no-load conditions, the energy delivered to the output capacitor when the external MOSFET in on during the blanking interval is more than what is delivered to the lead. An every r-voltage comparator inside the SCT81624 prevents the output voltage from rising under these conditions. The over-voltage comparator senses the feedback (FB pin) voltage and resets the RS latch. The latch remains in reset state until the output decays to the nominal value.

The SCT81624 works at Pulse skip mode to further increase the efficiency in light load condition.

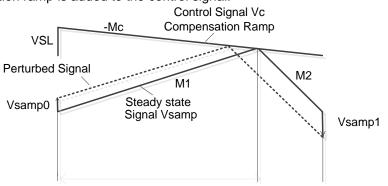
The quiescent current of SCT81624 is 415uA typical under no-load condition and no switching. Disabling the device, the typical supply shutdown current on VIN pin is 3.9

### **Overvoltage Protection**

The SCT81624 has over voltage protection (OVP) for the output voltage. OVP is sensed at the feedback pin (FB). If at any time the voltage at the feedback pin rises to 1.36V (typ.), OVP is triggered. OVP will cause the DR pin to go low, forcing the power MOSFET off. With the MOSFET off, the output voltage will drop. The SCT81624 begins switching again when the feedback voltage reaches 1.29V (typ.).

### Slope Compensation Ramp

The SCT81624 uses a current mode control scheme. The main advantages of current mode control are inherent cycle-by-cycle current limit for the switch and simpler control loop characteristics. However, current mode control has a Sub-harmonic Oscillation when duty cycle is greater than 50%. To prevent the Sub-harmonic oscillations, a compensation ramp is added to the control signal.





A typical value for factor K is 40 µA.

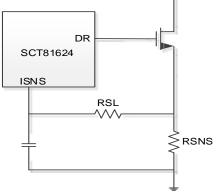


Figure14. External RSL to increase slope compensation





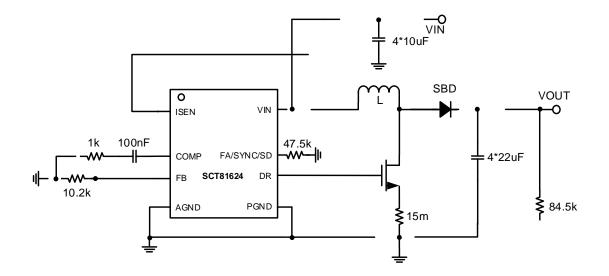
## Enable and Under Voltage Lockout Threshold

The external UVLO resistor divider must be designed so that the voltage at the UVLO pin is greater than 1.42 V typical) when the input voltage is in the desired operating range. The values of R1 and R2 can be calculated as shown in Equation 14 and Equation 15.

R1 \_\_\_\_\_ IN(ON) \_\_\_\_\_ IN(OFF)



# **Typical Application (Boost)**





### Inductor Selection (Boost)

The performance of inductor affects the power supply's steady state operation, transient behavior, loop stability, and boost converter efficiency. The inductor value, DC resistance, and saturation current influences both efficiency and the magnitude of the output voltage ripple. Larger inductance value reduces inductor current ripple and therefore leads to lower output voltage ripple. For a fixed DC resistance, a larger value inductor yields higher efficiency via reduced RMS and core losses. However, a larger inductor within a given inductor family will generally have a greater series resistance, thereby counteracting this efficiency advantage.

Inductor values can have  $\pm 20\%$  or even  $\pm 50\%$  tolerance with no current bias. When the inductor current approaches saturation level, its inductance can decrease 20% to 35% from the value at 0-



The input capacitor should be capable of handling the RMS current. Although the input capacitor is not as critical in a boost application, low values can cause impedance interactions. Therefore, a good quality capacitor should be chosen in the range of 10  $\mu$ F to 40  $\mu$ F. If a value lower than 10  $\mu$ F is used, then problems with impedance interactions or switching noise can affect the SCT81624. To improve performance, especially with Vin below 8 volts, it is recommended to use a 2.2 Ohm resistor at the input to provide an RC filter. The resistor is placed in series with the VIN pin with only a bypass capacitor attached to the VIN pin directly. A 0.1  $\mu$ F or 1  $\mu$ F coramic capacitor is necessary in this configuration. The bulk input capacitor and inductor will connect on the other side of the resistor at the input power supply.

## **Output Capacitor Selection**

For small output voltage ripple, choose a low-ESR output capacitor like a ceramic capacito. Typically, 3 4x ceramic output capacitors work for most applications.

placed as close as possible to the switch node Higher capacitor values can be used to improve the load transient response. Due to a capacitor's derating under DC bias, the bias can significantly reduce capacitance. Ceramic capacitors can lose most of their capacitance at rated voltage. Therefore, leave margin on the voltage rating to ensure adequate effective capacitance. From the required output voltage ripple, use the equation 20 and 21 to calculate the minimum required effective capacitance,  $C_{OUT}$ .

$$= \frac{( ) \times }{ \times \times }$$
(20)

where

- V<sub>ripple\_C</sub> is output voltage ripple caused by charging and discharging of the output capacitor.
- V<sub>ripple\_ESR</sub> is output voltage ripple caused by ESR of the output capacitor.
- V<sub>IN\_MIN</sub> is the minimum input voltage of boost converter.
- VOUT is the output voltage.

X

- I<sub>OUT</sub> is the output current.
- I<sub>Lpeak</sub> is the peak current of the inductor.
- $f_{SW}$  is the converter switching frequency.
- ESR is the ESR resistance of the output capacitors.

## **Power MOSFET Selection**

The following parameters should be taken into consideration for MOSFET: the on-resistance  $R_{DS_ON}$ , the minimum gate threshold voltage  $V_{TH_MIN}$ , the total gate charge  $Q_g$ , the reverse transfer capacitance  $C_{RSS}$ , and the maximum drain to source voltage  $V_{Q_MAX}$ . The peak switching voltage between drain to source in a Boost is given by

$$V_{SW_{PEAK}} = V_{IN} + V_D \tag{22}$$

Then the  $V_{Q_{MAX}}$  of power MOSFET should be greater than the peak switching voltage.

The peak switching current flowing through the MOSFET is given by:

$$I_{Q\_PEAK} = I_{LPEAK}$$
(23)

The RMS current through the MOSFET is calculated by:

$$I_{Q_{-RMS}} = \sqrt{(I_{LDC}^2 + \frac{I_{LPP}}{12}) * D}$$
(24)

Then power dissipation in MOSFET can be estimated by:

$$P_{DIS} = I_{Q_{-}RMS}^{2} \times R_{DS_{-}ON} \times D_{MAX} + \left(V_{O} + V_{IN_{-}MIN}\right) \times I_{Q_{-}PEAK} \times \frac{Q_{g} \times f_{SW}}{I_{G}}$$
(25)



(21)

### Where

 $I_{\rm G}$  is the gate drive current.

The total power dissipation of MOSFET includes conduction loss as shown in the first term and switching loss as shown in the second term. The total power dissipation should be within package thermal ratings.

## **Output Diode Selection**

Observation of the boost converter circuit shows that the average current through the diode is the average load current, and the peak current through the diode is the peak current through the inductor. The diode should be rated to handle more than its peak current. The peak diode current can be calculated using Equation 26.

$$I_{D(PEAK)} = \frac{I_{OUT}}{(1-D)} + \Delta I_L$$

(26)



Application Waveforms

Vin=5V, Vout=12V, unless otherwise noted

Figure 21. Power up(Iload=2A)

Figure 22. Power down(Iload=2A)

Figure 23. Over current protection (Iload=5A)

Figure 24. Over current recovery (Iload=5A)



# **Typical Application(Sepic)**

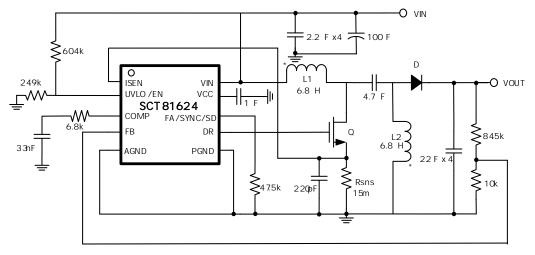


Figure 27. Application Schematic, 5V to 50V, 2A Sepic Regulator at 400kHz

Design Parameters			
Design Parameters	Example Value		
Input Voltage	24V Normal 5V to 50V		
Output Voltage	12V		
Maximum Output Current	2A		
Switching Frequency	400 KHz		
Output voltage ripple (peak to peak)	75mV (Load=2A)		

## **Design Parameters**



## Inductor Selection (Sepic)

A good rule for determining the inductance to use is to allow the inductor peak-to-peak ripple current to be approximately 20% to 40% of the maximum input current at the minimum input voltage. The current ripple flowing in inductors L1 and L2 is given by:

$$\Delta I_{L1} = I_{IN} \times 40\% = I_O \times \frac{V_O}{V_{IN} - MIN} \times 40\%$$
<sup>(27)</sup>

$$\Delta I_{L2} = I_0 \times 40\% = I_0 \times 40\% \tag{28}$$

Normally we can select equal value for the inductors L1 and L2, derived as:

$$L_1 = L_2 = L = \frac{V_{IN\_MIN}}{\Delta I_L \times f_{SW}} \times D_{MAX}$$
<sup>(29)</sup>

Where

 $f_{SW}$  is the switching frequency.

Note that the saturation current of inductors should be greater than peak current flowing in inductors, given by:

$$I_{L1_{PEAK}} = I_{IN} + \frac{\Delta I_{L}}{2} = I_{O} \times \frac{V_{O}}{V_{IN_{MIN}}} \times (1 + \frac{40\%}{2})$$
(30)

$$I_{L2\_PEAK} = I_{O} + \frac{\Delta I_{L}}{2} = I_{O} \times (1 + \frac{40\%}{2})$$
(31)

If L1 and L2 are wound in same core as a coupled inductor, the inductance required will be half due to the mutual induction, calculated by:

$$L_1 = L_2 = \frac{L}{2} = \frac{V_{IN\_MIN}}{2 \times \Delta I_L \times f_{SW}} \times D_{MAX}$$
(32)

### **Power MOSFET Selection**

The following parameters should be taken into consideration for MOSFET: the on-resistance  $R_{DS_ON}$ , the minimum gate threshold voltage  $V_{TH_MIN}$ , the total gate charge  $Q_g$ , the reverse transfer capacitance  $C_{RSS}$ , and the maximum drain to source voltage  $V_{Q_MAX}$ . The peak switching voltage between drain to source in a SEPIC is given by:

$$V_{SW_{PEAK}} = V_{IN} + V_O + V_D \tag{33}$$

Then the VQ\_MAX of power MOSFET should be greater than the peak switching voltage.

The peak switching current flowing through the MOSFET is given by:

$$I_{Q_{-}PEAK} = I_{L1_{-}PEAK} + I_{L2_{-}PEAK}$$
(34)

The RMS current through the MOSFET I s calculated by:

$$I_{Q_{RMS}} = I_O \times \sqrt{\frac{\left(V_O + V_{IN_{MIN}} + V_D\right) \times \left(V_O + V_D\right)}{V_{IN_{MIN}}^2}}$$
(35)

Then power dissipation in MOSFET can be estimated by:

$$P_{DIS} = I_{Q_{-}RMS}^2 \times R_{DS_{-}ON} \times D_{MAX} + \left(V_O + V_{IN_{-}MIN}\right) \times I_{Q_{-}PEAK} \times \frac{Q_g \times f_{SW}}{I_G}$$
(36)

Where

 $I_{\rm G}$  is the gate drive current.

The total power dissipation of MOSFET includes conduction loss as shown in the first term and switching loss as shown in the second term. The total power dissipation should be within package thermal ratings.

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## **Output Diode Selection**

The diode at the output side must withstand the reverse voltage when the MOSFET is turned-on. The peak reverse voltage is given by:

$$V_{D_{-}PEAK} = V_{IN_{-}MAX} + V_{O_{-}MAX}$$
(37)

The diode should also be capable to flow switch peak current  $I_{Q\_PEAK}$ .

The power dissipation of the diode is equal to the forward voltage drop multiplies output current. Schottky diodes are recommended here to minimize the power loss.

## **Coupling Capacitor Selection**

For ceramic capacitors with low-ESR, the peak to peak voltage ripple on coupling capacitor is estimated by:

$$\Delta V_{CS} = \frac{I_O \times D_{MAX}}{C_S \times f_{SW}} \tag{38}$$

The maximum voltage across the coupling capacitor is maximum input voltage. The voltage rating of the coupling capacitor must be greater than it.

The RMS current of coupling capacitor is given by:

$$I_{CS\_RMS} = I_O \times \sqrt{\frac{V_O + V_D}{V_{IN\_MIN}}}$$
(39)

There is a large RMS current through coupling capacitor relative to output power. Ensure the coupling capacitor can withstand it with good heat generation to have proper thermal performance.

## **Input Capacitor Selection**

The SEPIC has an inductor at input side thus the input current is continuous and triangular. The RMS current flowing through the input capacitor is given by:

$$I_{IN\_RMS} = \frac{\Delta I_{L1}}{\sqrt{12}} \tag{40}$$

Since input current ripple is relative low, the capacitance would be not too critical. While 100 F in total or higher value is strongly recommended in order to provide stable input supply.

## **Output Capacitor Selection**

Similar to boost converter, the SEPIC output capacitor suffers large current ripple. The capacitance must be enough to provide the load current. The maximum voltage ripple in the output capacitor is:

$$\Delta V_{OUT} = \frac{I_O \times D_{MAX}}{C_{OUT} \times f_{SW}} + ESR \times \left( I_{L1\_PEAK} + I_{L2\_PEAK} \right)$$
(41)

Assuming ceramic capacitors are used here and ESR can be ignored, the output capacitor is given by:

$$C_{OUT} \ge \frac{I_O \times D_{MAX}}{\Delta V_{OUT} \times f_{SW}}$$
(42)

The output capacitor must have an enough RMS current rating to handle the maximum RMS current in the output capacitor, calculated by:

$$I_{COUT\_RMS} = I_O \times \sqrt{\frac{D_{MAX}}{1 - D_{MAX}}}$$
(43)



Application Waveforms Vin=5V, Vout=12V, unless otherwise noted

Figure 29. Power up(Iload=2A)

Figure 30. Power down(Iload=2A)

Figure 31.



# Layout Guideline

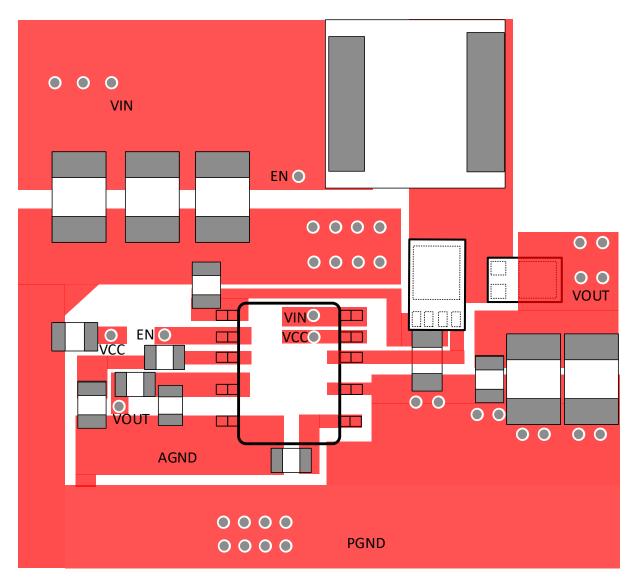
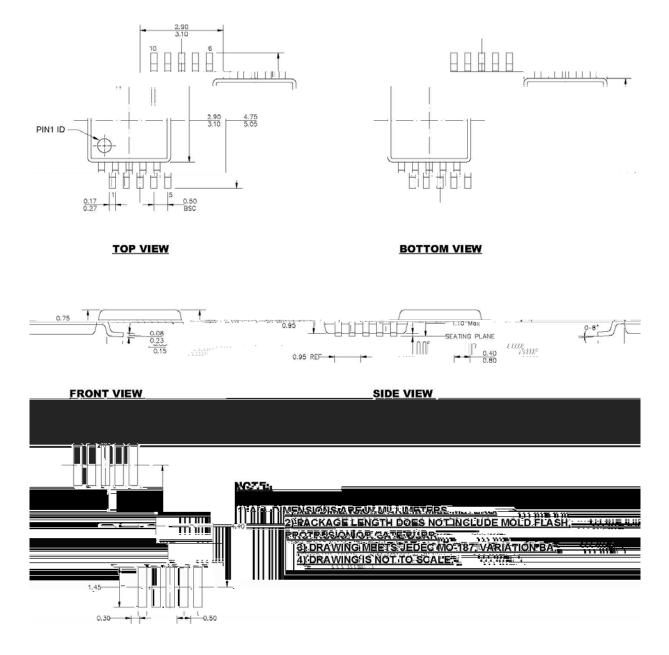


Figure 35. BOOST PCB Layout





## RECOMMENDED LAND PATTERN

